

# HLMP-LB11/HLMP-LM11

4 mm Precision Optical Performance  
InGaN Standard Oval LED Lamps



## Data Sheet



### Description

These Precision Optical Performance Oval LEDs are specifically designed for full color/video and passenger information signs. The oval shaped radiation pattern and high luminous intensity ensure that this device is excellent for wide field of view outdoor applications where a wide viewing angle and readability in sunlight are essential. This lamp has very smooth, matched radiation patterns ensuring consistent color mixing in full color applications, message uniformity across the viewing angle of the sign. High efficiency LED material is used in this lamp: Indium Gallium Nitride for Blue and Green. Each lamp is made with an advanced optical grade epoxy offering superior high temperature and high moisture resistance in outdoor applications. The package epoxy contains both UV-a and UV-b inhibitors to reduce the effects of long term exposure to direct sunlight.

### Features

- Well defined spatial radiation pattern
- High brightness material
  - Blue InGaN 470 nm
  - Green InGaN 525 nm

### Applications

- Full color signs
- Commercial outdoor advertising

### Benefits

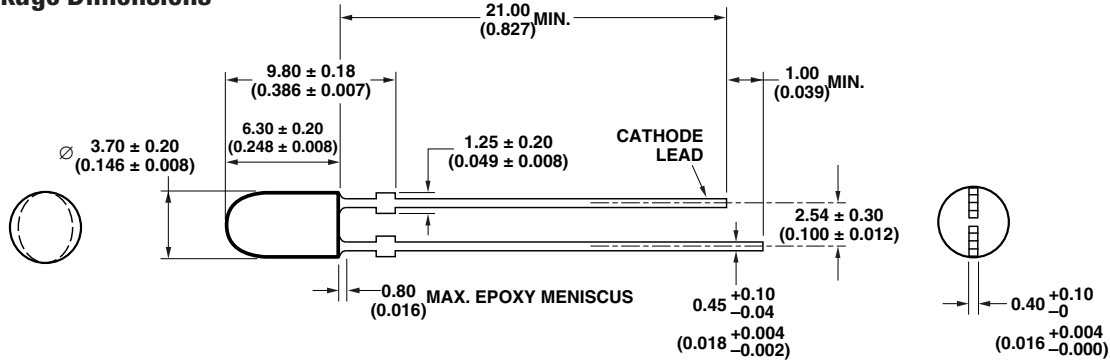
- Viewing angle designed for wide field of view applications
- Superior performance for outdoor environments

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**CAUTION:** Devices are Class I ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Application Note AN-1142 for additional details.

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## Package Dimensions



### NOTES:

1. DIMENSIONS IN MILLIMETERS (INCHES).
2. TOLERANCE  $\pm 0.1$  mm UNLESS OTHERWISE NOTED.

## Device Selection Guide

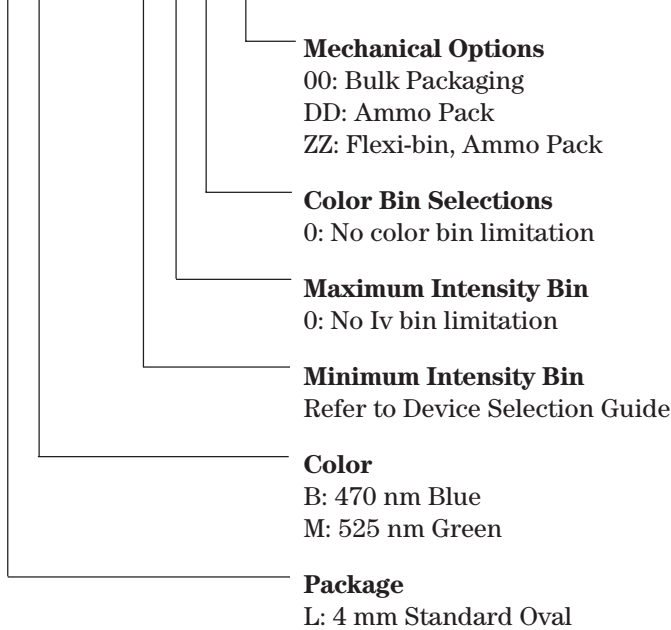
| Part Number     | Color and Dominant Wavelength $\lambda_d$ (nm) Typ. | Luminous Intensity $I_v$ (mcd) at 20 mA Min. | Luminous Intensity $I_v$ (mcd) at 20 mA Max. | Tinting Type |
|-----------------|---|--|--|--------------|
| HLMP-LB11-FJ0xx | Blue 470  | 110  | 310  | Blue         |
| HLMP-LB11-HJCxx | Blue 470  | 180  | 310  | Blue         |
| HLMP-LB11-HL0xx | Blue 470  | 180  | 520  | Blue         |
| HLMP-LB11-JKCxx | Blue 470  | 240  | 400  | Blue         |
| HLMP-LB11-KN0xx | Blue 470  | 310  | 880  | Blue         |
| HLMP-LM11-LP0xx | Green 525   | 400  | 1150   | Green        |
| HLMP-LM11-MNCxx | Green 525   | 520  | 880  | Green        |
| HLMP-LM11-NR0xx | Green 525   | 680  | 1900   | Green        |
| HLMP-LM11-PQCxx | Green 525   | 880  | 1500   | Green        |
| HLMP-LM11-QRCxx | Green 525   | 1150   | 1900   | Green        |
| HLMP-LM11-QT0xx | Green 525   | 1150   | 3200   | Green        |

### Notes:

1. The luminous intensity is measured on the mechanical axis of the lamp package.
2. The optical axis is closely aligned with the package mechanical axis.
3. The dominant wavelength,  $\lambda_d$ , is derived from the Chromaticity Diagram and represents the color of the lamp.
4. Tolerance for intensity limit is  $\pm 15\%$ .

## Part Numbering System

HLMP-X X 11 - X X X XX



## Absolute Maximum Ratings at $T_A = 25^\circ\text{C}$

| Parameter                                  | Value                          |
|--|--------------------------------|
| DC Forward Current <sup>[1]</sup>          | 30 mA                          |
| Peak Pulsed Forward Current <sup>[2]</sup> | 100 mA                         |
| Power Dissipation                          | 130 mW                         |
| Reverse Voltage                            | 5 V ( $I_R = 10 \mu\text{A}$ ) |
| LED Junction Temperature                   | 130°C                          |
| Operating Temperature Range                | -40°C to +80°C                 |
| Storage Temperature Range                  | -40°C to +100°C                |

### Notes:

1. Derate linearly as shown in Figure 3.
2. Duty Factor 10%, Frequency 1 kHz.

## Electrical / Optical Characteristics Table

$T_A = 25^\circ\text{C}$

| Parameter                             | Symbol                | Min. | Typ. | Max. | Units              | Test Conditions   |
|---------------------------------------|-----------------------|------|------|------|--------------------|---|
| Forward Voltage                       |                       |      |      |      |                    |   |
| Blue ( $\lambda_d = 470\text{ nm}$ )  | $V_F$                 |      | 3.8  | 4.0  | V                  | $I_F = 20\text{ mA}$  |
| Green ( $\lambda_d = 525\text{ nm}$ ) |                       |      | 3.8  | 4.0  |                    |   |
| Reverse Voltage                       | $V_R$                 | 5    |      |      | V                  | $I_R = 10\text{ }\mu\text{A}$   |
| Capacitance                           |                       |      |      |      |                    |   |
| Blue ( $\lambda_d = 470\text{ nm}$ )  | C                     |      | 43   |      | pF                 | $V_F = 0, f = 1\text{ MHz}$   |
| Green ( $\lambda_d = 525\text{ nm}$ ) |                       |      | 43   |      |                    |   |
| Thermal Resistance                    | $R_{\theta J-PIN}$    |      | 240  |      | $^\circ\text{C/W}$ | LED Junction-to-Cathode Lead  |
| Peak Wavelength                       |                       |      |      |      |                    |   |
| Blue ( $\lambda_d = 470\text{ nm}$ )  | $\lambda_P$           |      | 467  |      | nm                 | Peak of Wavelength of Spectral Distribution at $I_F = 20\text{ mA}$           |
| Green ( $\lambda_d = 525\text{ nm}$ ) |                       |      | 520  |      |                    |   |
| Spectral Halfwidth                    |                       |      |      |      |                    |   |
| Blue ( $\lambda_d = 470\text{ nm}$ )  | $\Delta\lambda_{1/2}$ |      | 24   |      | nm                 | Wavelength Width at Spectral Distribution Power Point at $I_F = 20\text{ mA}$ |
| Green ( $\lambda_d = 525\text{ nm}$ ) |                       |      | 35   |      |                    |   |
| Luminous Efficacy                     |                       |      |      |      |                    |   |
| Blue ( $\lambda_d = 470\text{ nm}$ )  | $\eta_v$              |      | 75   |      | $\text{lm/W}$      | Emitted luminous power/Emitted radiant power                                  |
| Green ( $\lambda_d = 525\text{ nm}$ ) |                       |      | 520  |      |                    |   |

### Notes:

1.  $2\theta_{1/2}$  is the off-axis angle where the luminous intensity is  $1/2$  the on axis intensity.
2. The radiant intensity,  $I_e$  in watts per steradian, may be found from the equation  $I_e = I_v/\eta_v$  where  $I_v$  is the luminous intensity in candelas and  $\eta_v$  is the luminous efficacy in lumens/watt.

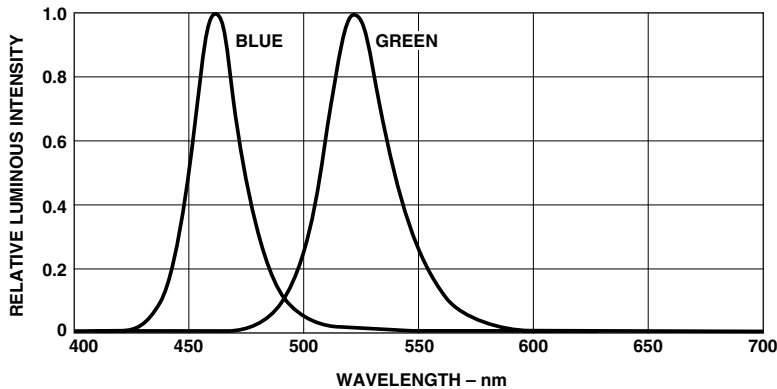


Figure 1. Relative intensity vs. wavelength.

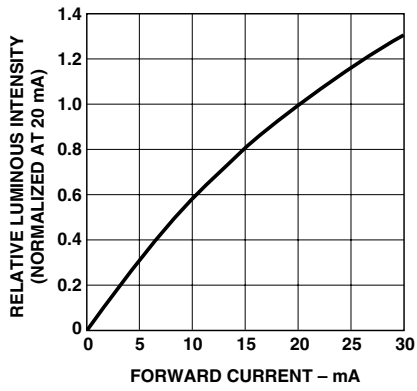


Figure 2. Relative luminous intensity vs. forward current.

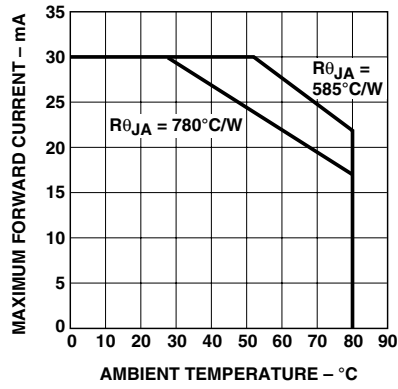


Figure 3. Forward current vs. ambient temperature.

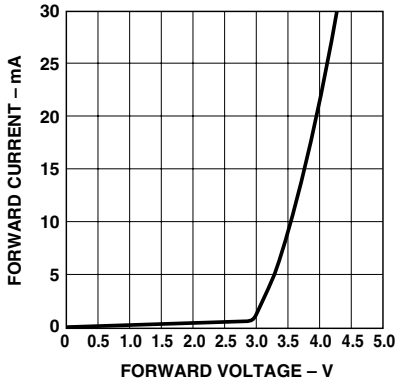


Figure 4. Forward current vs. forward voltage.

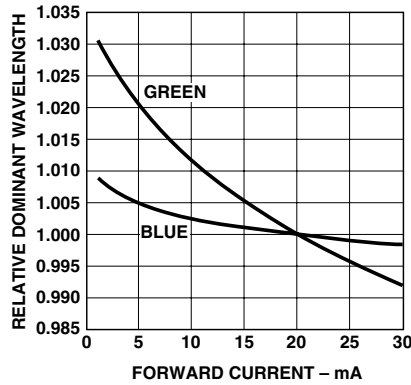


Figure 5. Relative dominant wavelength vs. forward current.

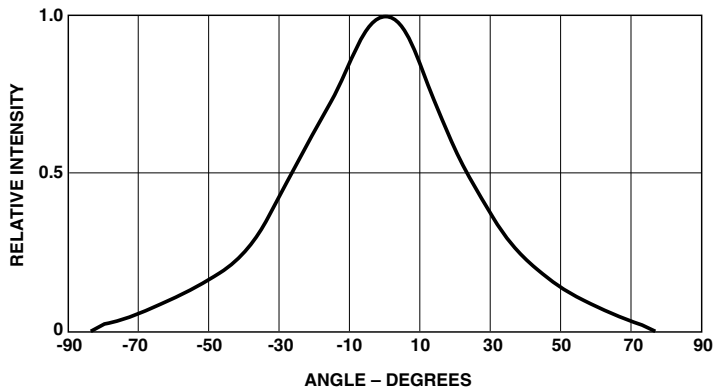


Figure 6. Spatial radiation pattern - minor axis.

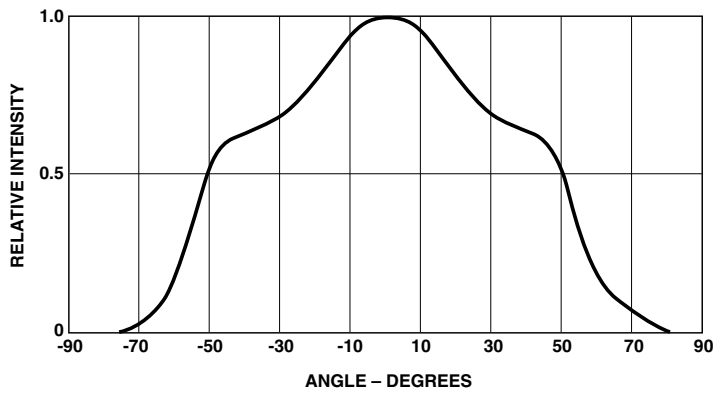


Figure 7. Spatial radiation pattern – major axis.

### Intensity Bin Limits (mcd @ 20 mA)

| Bin Name | Min. | Max. |
|----------|------|------|
| F        | 110  | 140  |
| G        | 140  | 180  |
| H        | 180  | 240  |
| J        | 240  | 310  |
| K        | 310  | 400  |
| L        | 400  | 520  |
| M        | 520  | 680  |
| N        | 680  | 880  |
| P        | 880  | 1150 |
| Q        | 1150 | 1500 |
| R        | 1500 | 1900 |

Tolerance for each intensity bin limit is  $\pm 15\%$ .

### Color Bin Limits (nm at 20 mA)

| Blue | Color Range (nm) |       |
|------|------------------|-------|
| Bin  | Min.             | Max.  |
| 1    | 460.0            | 464.0 |
| 2    | 464.0            | 468.0 |
| 3    | 468.0            | 472.0 |
| 4    | 472.0            | 476.0 |
| 5    | 476.0            | 480.0 |

Tolerance for each bin limit is  $\pm 0.5$  nm.

**Note:**

1. Bin categories are established for classification of products. Products may not be available in all bin categories.

| Green | Color Range (nm) |       |
|-------|------------------|-------|
| Bin   | Min.             | Max.  |
| 1     | 520.0            | 524.0 |
| 2     | 524.0            | 528.0 |
| 3     | 528.0            | 532.0 |
| 4     | 532.0            | 536.0 |
| 5     | 536.0            | 540.0 |

Tolerance for each bin limit is  $\pm 0.5$  nm.

**Precautions:**

**Lead Forming**

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering into PC board.
- If lead forming is required before soldering, care must be taken to avoid any excessive mechanical stress induced to LED package. Otherwise, cut the leads of LED to length after soldering process at room temperature. The solder joint formed will absorb the mechanical stress of the lead cutting from traveling to the LED chip die attach and wirebond.
- It is recommended that tooling made to precisely form and cut the leads to length rather than rely upon hand operation.

**Soldering Conditions**

- Care must be taken during PCB assembly and soldering process to prevent damage to LED component.
- The closest LED is allowed to solder on board is 1.59 mm below the body (encapsulant epoxy) for those parts without standoff.
- Recommended soldering conditions:

|                      | Wave Soldering | Manual Solder Dipping |
|----------------------|----------------|-----------------------|
| Pre-heat Temperature | 105 °C Max.    | –                     |
| Pre-heat Time        | 30 sec Max.    | –                     |
| Peak Temperature     | 250 °C Max.    | 260 °C Max.           |
| Dwell Time           | 3 sec Max.     | 5 sec Max.            |

- Wave soldering parameter must be set and maintained according to recommended temperature and dwell time in the solder wave. Customer is advised to periodically check on the soldering profile to ensure the soldering profile used is always conforming to recommended soldering condition.
- If necessary, use fixture to hold the LED component in proper orientation with respect to the PCB during soldering process.
- Proper handling is imperative to avoid excessive thermal stresses to LED components when heated. Therefore, the soldered PCB must be allowed to cool to room temperature, 25°C, before handling.
- Special attention must be given to board fabrication, solder masking, surface plating and lead holes size and component orientation to assure solderability.
- Recommended PC board plated through hole sizes for LED component leads:

| LED Component Lead Size                  | Diagonal                 | Plated Through Hole Diameter               |
|--|--------------------------|--|
| 0.457 x 0.457 mm<br>(0.018 x 0.018 inch) | 0.646 mm<br>(0.025 inch) | 0.976 to 1.078 mm<br>(0.038 to 0.042 inch) |
| 0.508 x 0.508 mm<br>(0.020 x 0.020 inch) | 0.718 mm<br>(0.028 inch) | 1.049 to 1.150 mm<br>(0.041 to 0.045 inch) |

**Note:** Refer to application note AN1027 for more information on soldering LED components.

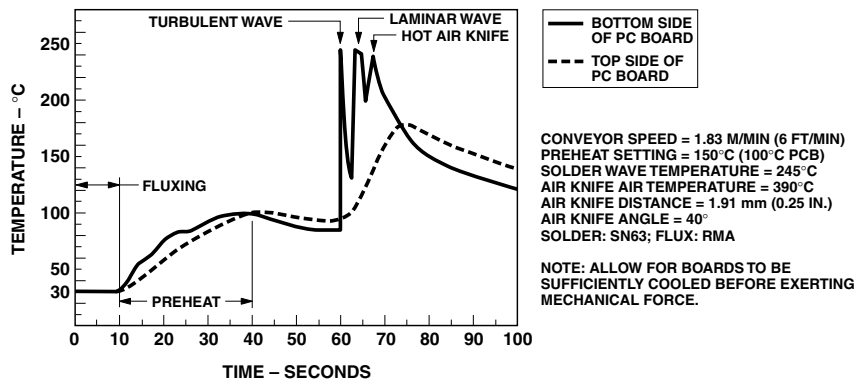


Figure 8. Recommended wave soldering profile.

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